





The OX-208 is a high stability ovenized crystal oscillator in a 25 x 25 mm package, capable of aging rates of 0.15 ppb/day and temperature stabilities of 0.8 ppb over an industrial temperature range. The Microsemi design team will also help develop custom solutions where performance optimization is required for specific applications. Please contact the factory for customization options.

Features

- Reflow Process Compatible
- SC-Cut resonation
- Temperature stability to 0.4 ppb
- Aging rate 0.15 ppb/day
- Frequency Range 5 to 20 MHz
- Standard Frequencies: 5, 10, 20 MHz

Applications

- Holdover reference
- Test equipment
- Synthesizers
- Military communication equipment
- Digital Switching

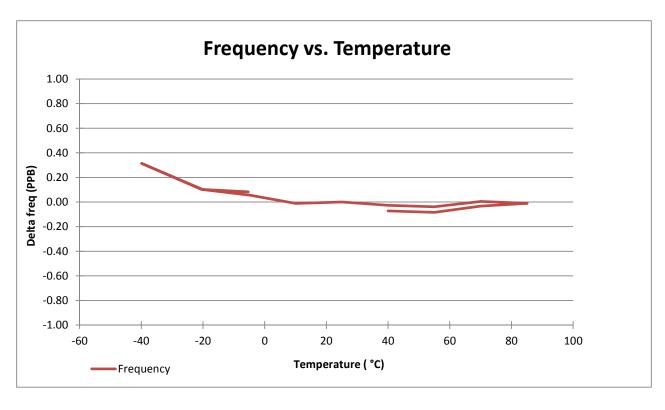
Performance Specifications

Frequency Stabilities¹ (Stabilities listed for 10 MHz unless otherwise noted, for stabilities above 10 MHz values may degrade, please contact factory)					
Parameter	Min	Typical	Max	Units	Condition
vs. operating temperature range (referenced to +25°C)	-0.4 -0.6 -0.8 -1 -2		+0.4 +0.6 +0.8 1 2	ppb ppb ppb ppb ppb	0 to +70°C (f=< 10 MHz) -20 to +70°C (f=< 10 MHz) -40 to +85°C (f=< 10 MHz) 0 to +70°C (f>10 MHz) -40 to +85°C (f>10 MHz)
	For better stability refer to the MX-060 or MX-041 datasheets				-060 or MX-041 datasheets
Initial tolerance vs. supply voltage change vs. load change vs. aging / day vs. aging / year vs. aging / year (following year) vs. aging/ 10 years	-25 -0.5 -0.5 -0.15 -20 -15 -100		+25 +0.5 +0.5 +0.15 +20 +15 +100	ppb ppb ppb ppb ppb ppb	at time of shipment, nominal EFC $V_s\pm5\%$ Load $\pm5\%$ after 72 hours operation (f=< 10 MHz) after 72 hours operation (f=< 10 MHz) after 72 hours operation (f=< 10 MHz)
vs. aging / day vs. aging / year vs. aging / year (following year) vs. aging / day	-0.3 -40 -30 -200		+0.3 +40 +30 +200		after 72 hours operation (f> 10 MHz) after 72 hours operation (f> 10 MHz) after 72 hours operation (f> 10 MHz)
retrace ²	-5		+5	ppb	
Warm-up time			5	minutes	to ±10 ppb of final frequency (1 hour reading) @ +25°C

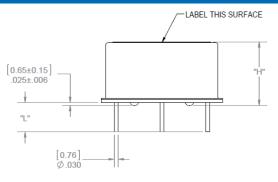
Performance Specifications

Supply Voltage (Vs)						
Parameter	Min	Typical	Max	Units	Condition	
Complete (Approximately)	3.135	3.3	3.465	VDC	Ordering Code E	
Supply Voltage (Vs)	4.75	5.0	5.25	VDC	Ordering Code D	
			4.5	Watts	during warm-up, all tempera	atures
			2	Watts	steady state @ +25°C	
Power Consumption		4.5		Watts	steady state @ -40°C	
		1		Watt	steady state @ +85°C	
			RF Output	t		
start time		1	2	S	time required to achieve 90% of	amplitude
Signal [standard]		HCI	MOS			
Load		15		pF		
Circulational (Val)			0.3	VDC	with Vs=3.3V and 15pF Lo	ad
Signal Level (Vol)			0.4	VDC	with Vs=5.0V and 15pF Lo	ad
Circulational (Mala)	2.5			VDC	with Vs=3.3V and 15pF Lo	ad
Signal Level (Voh)	3.6				with Vs=5.0V and 15pF Lo	ad
Duty Cycle	45		55	%	@ (Voh-Vol)/2	
Signal		Sine	Wave			
Load		50		Ω		
Output Power @3.3V	2	5	8	dBm		
Output Power @ 5.0V	5	8	11	dBm		
Harmonics			-40	dBc		
		Frequ	iency Tunin	g (EFC)		
Tuning Range	±250		±500	ppb	(fixed frequency option avai	lable)
Linearity		10		%		
Tuning Slope		Pos	itive			
Input Impedance		100		kOhm		
Bandwidth Modulation	150			Hz		
Control Voltage Range	0.0	1.4	2.8	VDC	with Vs=3.3V	
	0.0	2.0	4.0	VDC	with Vs=5.0V	
TI 07 2000 I C I	6		e Voltage Ou			
The OX-2080 can be configured w for ordering information.	ith a reference	voltage. This	s configuration	on requires a cu	stom part number. Please contact t	he factory
Reference Voltage	2.75	2.8	2.85	VDC	with Vs = 3.3 VDC	
	3.92	4.0	4.08	VDC	with Vs = 5.0 VDC	
			Phase Nois	!		
Parameter	Min	Typical	Max	Units	Condition	
- Faraniecei			-95	dBc/Hz	1 Hz	
			-125	dBc/Hz	10 Hz	
Phase Noise ³			-140	dBc/Hz	100 Hz	@ 10MHz
			-155 -155	dBc/Hz dBc/Hz	1 kHz 10 kHz	
For lower phase please review the OX-174 datasheet.						
			-89	dBc/Hz	1 Hz	
			-119	dBc/Hz	10 Hz	
Phase Noise			-134 -140	dBc/Hz dBc/Hz	100 Hz 1 kHz	@ 20MHz
			-149 -155	dBc/Hz dBc/Hz	1 kHz	
i	<u> </u>	<u> </u>		1,	1	

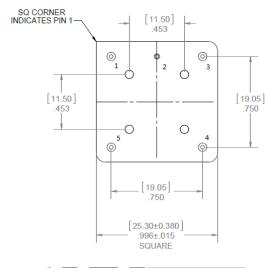
Additional Parameters						
Parameter	Min	Typical	Max	Units	Condition	
Allan deviation			5 8 1 5	E-12 E-12 E-11 E-11	1 s tau 10 s tau 100 s tau 1000 s tau	@ 10MHz
g-sensitivity		1			ppb/g	
g-sensitivity of 0.5 ppb/g availabl For g sensitivity <0.1 ppb/g pleas			e contact fac	tory for orderin	ng information.	
Weight			15	g		
		Absolu	te Maximur	n Ratings		
Supply Voltage (Vs)			6.5	V	with Vs=3.3 & 5.0 VDC	
Output Load			50	pF		
Operable Temperature Range	-55		+95	°C	operable temperature range implie device will continue to operate wit term damage to unit however it wi specification compliant outside the temperature range	h no long- Il not be
	Environmental and Product Classification					
Shock (Endurance)	MIL-STD-202, Method 213, Condition J, 30g 11 ms					
Sine Vibration (Endurance)	MIL-STD-202, Method 201 and 204, Condition A, except 5g to 500 Hz, 1 sweep each axis					
Random Vibration (Endurance)	MIL-STD-202, Method 214, Condition I-D					
Humidity	MIL-STD-202, Method 103, Condition B, 100% rh					
Seal	MIL-STD-202, Method 112, Condition D, hermetic, washable					
Altitude	MIL-STD-202, Method 105, sea level to space					
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition A,B,C					
Terminal Strength	MIL-STD-202, Method 211, Condition C (5 bends at 45°, 2 lbs)					
Moisture Sensitive Level	1					
RoHS	compliant with exemption 7c-i					
Storage Temperature Range	-55		+125	°C		



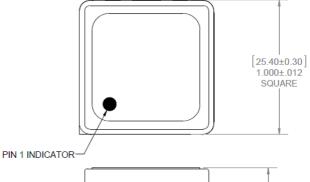
Outline Drawing / Enclosure



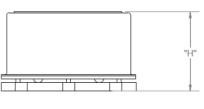




	Pin Connections
1	RF output
2	Ground (Case)
3	Electronic Frequency Control (EFC)
4	Reference Voltage option (requires custom part number)
5	Supply Voltage (Vs)





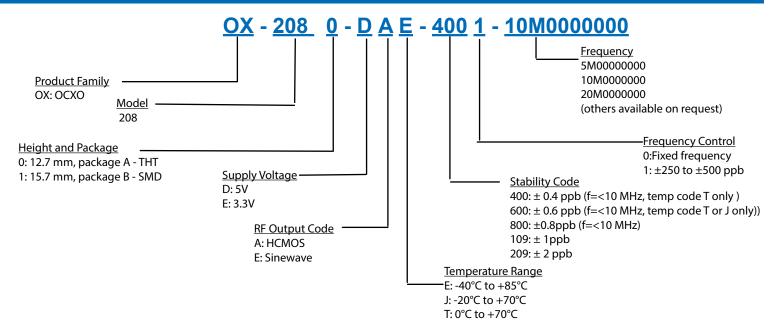


SMD Package configuration 1			
Height "H"			
1	15.7		

1	2	3	[2.54] .100
7	6 5 77.78±0.102 .700±.004		[7.62±0.102] .300±.004

Pin Connections				
1	Electronic Frequency Control Input (EFC) No Connect for Fixed frequency Oscillators			
2,5,6	No Connect			
3	Supply Voltage Input (Vs)			
4	RF Output			
7	Ground (Case)			

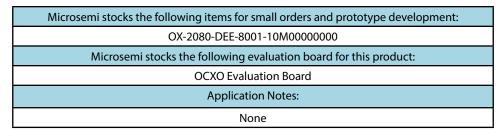
Ordering Information⁴



Additional Ordering Options

Additional ordering options available include custom heights, custom aging rates, custom temperature ranges, custom temperature stabilities, custom phase noise requirements, improved g-sensitivity, and oscillators with voltage reference output. on pin 4. These modifications require a custom dash number - please contact the factory for additional information.

Design Tools



Notes:

- 1. Unless otherwise stated, all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, and temperature (25°C).
- 2. Retrace defined as f1-f0 where fo is the reading after the unit has been on power for 24 hours, and f1 is the frequency after 24 hours off followed by 60 minutes on.
- 3. Phase noise degrades with increasing output frequency.
- 4. Not all options and codes available at all frequencies.



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